

PATENT APPLICATION

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October 11, 2006

Applicants : Toshihiro TAI et al
For : PLATED RESIN MOLDED ARTICLES
PCT International Application No.: PCT/JP2005/002827
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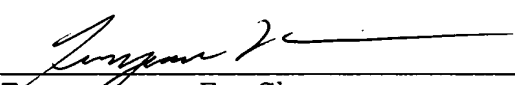
INFORMATION DISCLOSURE STATEMENT

Sir:

In compliance with the provisions of Rules 1.97(b)(1) and 1.98, enclosed herewith is a copy of the International Search Report, Form PTO-1449 and the references cited thereon. The relevance of these references is explained on the enclosed search report. The remaining references are mentioned in Applicants' specification. Further comment at this point in time should not be necessary.

Respectfully submitted,

TFC/smd


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Encl: International Search Report
Form PTO-1449 and one copy of each reference listed
thereon

336.05/03

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U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No.	Document Number - Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant
	AA			
	AB			
	AC			
	AD			
	AE			
	AF			
	AG			
	AH			
	AI			
	AJ			
	AK			

FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No.	Country Code - Document Number - Kind Code	Publication Date MM-DD-YYYY	Name of Patentee or Applicant	Trans.
	AL	JP 7-330934	12-19-1995	HOYA et al	Abstract
	AM	JP 57-123048	07-31-1982		
	AN	JP 59-142244	08-15-1984	OKITA et al	Abstract
	AO	JP 2004-2996	01-08-2004	TAI et al	Abstract
	AP	JP 2003-82138	03-19-2003	TAI et al	Abstract
	AQ	JP 2003-166067	06-13-2003	SOTOZAKI et al	Abstract

NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No.	(Include Author, Title, Date, Pages, Etc.)
	AQ	
	AR	
EXAMINER SIGNATURE		DATE CONSIDERED

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.